

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:  
Timothy M. Takeuchi

Serial No.: 10/038,806

Filed: January 2, 2002

For: SEMICONDUCTOR PACKAGE WITH  
INTEGRATED HEAT SPREADER  
ATTACHED TO A THERMALLY  
CONDUCTIVE SUBSTRATE CORE



Attorney Docket No.: 42390P13557

Group Art Unit: Not yet assigned

Examiner: Not yet assigned

## PETITION UNDER 37 CFR 1.182

## BOX PGPUB DRAWINGS

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Applicants respectfully request that the Formal Drawings enclosed herein, which are composed of seven (7) pages, Figures 1 through 7, be accepted as replacement drawings for publication in the above-referenced U.S. patent application. No new matter has been added.

A petition fee of \$130 is filed herewith. It is believed that this is the correct fee for this request, and no further fee is due with this submission; however, should any further fee be required for any reason relating to the enclosed materials, or any credit be due, please deduct or credit said fees to Blakely Sokoloff Taylor & Zafman LLP Deposit Account No. 02-2666. Please date stamp and return the enclosed postcard to acknowledge receipt of these materials.

Respectfully submitted,  
BLAKELY SOKOLOFF TAYLOR & ZAFMAN

Date: 1-29-02

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